Part Numbering

CERALOCK® (MHz)



Product ID

Product ID	
cs	Ceramic Resonators

Prequency/Capacitance

Code	Frequency/Capacitance			
Α	MHz No capacitance built-in			
Т	MHz Built-in Capacitance			

3Structure/Size

Code	Structure/Size			
LA	Lead Type			
LS	Round Lead Type			
CC	Cap Chip Type			
CR/CE/CG	Small-cap Chip Type			
CV	Monolithic Chip Type			
CW	Small Monolithic Chip Type			

4 Nominal Center Frequency

Expressed by four-digit alphanumerics. The unit is in hertz (MHz). Decimal point is expressed by capital letter "**M**".

6 Design

Code	Design
G□□	Thickness Shear mode
T/V□□	Thickness Expander mode
X	Thickness Expander mode (3rd overtone)

□□ indicates initial frequency tolerance and load capacity.

CERALOCK® (kHz)

(Global Part Number)	cs	В	FB	1M00	J58	***	-R1	
	Ω	9	8	•	A	A	a	

●Product ID

Product ID	
cs	Ceramic Resonators

2 Frequency/Capacitance

Code	Frequency/Capacitance
В	kHz No capacitance built-in

3Structure/Size

Code	Structure/Size
LA	Two-Terminal Lead Type
FB	SMD Type

4 Nominal Center Frequency

Expressed by four-digit alphanumerics. The unit is in hertz (Hz). Capital letter "K" following three figures expresses the unit of "kHz".

6 Individual Specification

Code	Individual Specification		
***	Three-digit alphanumerics express "Individual Specification".		
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With standard products, "Individual Specification" is omitted, and "Improved Package Specification Code" is carried up.

Packaging

Code	Packaging
-B0	Bulk
-A0	Radial Taping H ₀ =18mm
-A1	Radial Taping H ₀ =16mm
-R0	Plastic Taping ø=180mm
-R1	Plastic Taping ø=330mm

Radial taping is applied to lead type and plastic taping to chip type.

6 Design

Code	Design
E	Area Expansion mode
J	Area Expansion mode (Closed Type)

 $\Box\Box$ indicates initial frequency tolerance and load capacitance.

6 Individual Specification

Code	Individual Specification
***	Three-digit alphanumerics express "Individual Specification".
	individual Specification .

With standard products, "findividual Specification" is omitted, and "Package Specification Code" is carried up.

Packaging

Code	Packaging
-B0	Bulk
-R1	Plastic Taping ø=330mm



Ceramic Resonators (CERALOCK®)



Chip Type Three-Terminals CSTCC/E/G/R/V/W Series

Chip "CERALOCK" with built-in load capacitance in an extremely small package.

MURATA's package technology expertise has enabled the development of the Chip "CERALOCK" with built-in load capacitors.

High-density mounting can be realized because of the small package and the elimination of the need for an external load capacitor.

■ Features

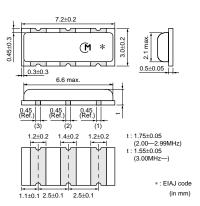
- Oscillation circuits do not require external load capacitors.
- 2. The series is available in a wide frequency range.
- 3. The resonators are extremely small and have a low profile.
- 4. No adjustment is necessary for oscillation circuits.

■ Applications

- · Clock oscillators for microprocessors.
- Electronic control circuits for small electronic equipment such as hand held movie.
- Audio-visual applications (Camcorder, Remote Controller, etc.)
- Office automation equipments (DVD, CD-ROM, HDD, FDD, etc.)
- Automotive electronics.
 (CSTCC_G_A series, CSTCR_G_A series, CSTCE_G_A series, CSTCV_X_Q series)
- Dual Tone Multi Frequency (DTMF) generator for cordless telephones.

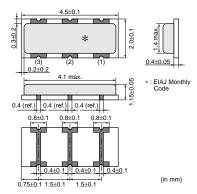


CSTCC_G(_A) 2.00-3.99MHz



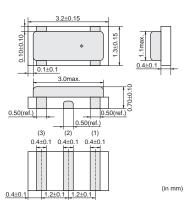


CSTCR_G(_A) 4.00-7.99MHz



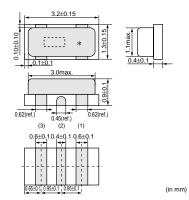


CSTCE_G(_A) 8.00-12.50MHz



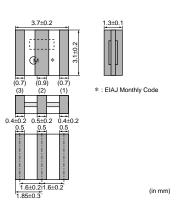


CSTCE_V 12.51-19.99MHz





CSTCV_X_Q 14.70-70.00MHz



Continued on the following page.



